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 Three Bidirectional Transceivers Driver Meets or Exceeds the Requirements 	DW OR J PACKAGE (TOP VIEW)
of ANSI EIA/TIA-422-B and RS-485 and ITU	1R 1 20 1B
Recommendation V.11	1DE 2 19 1A
Two Skew Limits Available	1D [3 18] RE
 Designed to Operate Up to 20 Million Data	GND 4 17 CDE
Transfers per Second (FAST-20 SCSI)	GND 5 16 V _{CC}
 High-Speed Advanced Low-Power Schottky	2R [] 6 15]] 2B
Circuitry	2DE [] 7 14]] 2A
• Low Pulse Skew 5 ns Max	2D [8 13] 3B
 Designed for Multipoint Transmission on	3R 9 12 3A
Long Bus Lines in Noisy Environments	3DE 10 11 3D

- Features Independent Driver Enables and Combined Receiver Enables
- Wide Positive and Negative Input/Output Bus Voltages Ranges
- Driver Output Capacity . . . ±60 mA
- Thermal Shutdown Protection
- Driver Positive- and Negative-Current Limiting
- Receiver Input Impedances . . . 12 kΩ Min
- Receiver Input Sensitivity . . . ±300 mV Max
- Receiver Input Hysteresis . . . 60 mV Typ
- Operates From a Single 5-V Supply
- Glitch-Free Power-Up and Power-Down
 Protection

description

The SN75ALS171 and the SN75ALS171A triple differential bus transceivers are monolithic integrated circuits designed for bidirectional data communication on multipoint bus transmission lines. They are designed for balanced transmission lines, and each driver meets ANSI Standards EIA/TIA-422-B and RS-485 and both the drivers and receivers meet ITU Recommendation V.11. The SN75ALS171A is designed for FAST-20 SCSI and can transmit or receive data pulses as short as 30 ns with a maximum skew of 5 ns.

The SN75ALS171 and the SN75ALS171A operate from a single 5-V power supply. The drivers and receivers have individual active-high and active-low enables, respectively, which can be externally connected together to function as a direction control. The driver differential output and the receiver differential input pairs are connected internally to form differential input/output (I/O) bus ports that are designed to offer minimum loading to the bus when the driver is disabled or V_{CC} is at 0 V. These ports feature wide positive and negative common-mode voltage ranges making the device suitable for party-line applications.

The SN75ALS171 and the SN75ALS171A are characterized for operation from 0°C to 70°C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



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Function Tables

EACH DRIVER						
INPUT	ENABLES		OUT	PUTS		
D	DE	CDE	Α	В		
Н	Н	Н	Н	L		
L	н	Н	L	н		
Х	L	Х	z	Z		
х	Х	L	z	Z		

EACH RECEIVER

DIFFERENTIAL INPUTS A-B	ENABLE RE	OUTPUT R
$V_{ID} \ge 0.3 V$	L	н
$-0.3 \text{ V} < \text{V}_{\text{ID}} < 0.3 \text{ V}$	L	?
$V_{ID} \leq -0.3 V$	L	L
Х	н	Z
Open	L	Н

H = high level, L = low level, ? = indeterminate, X = irrelevant, Z = high impedance (off)

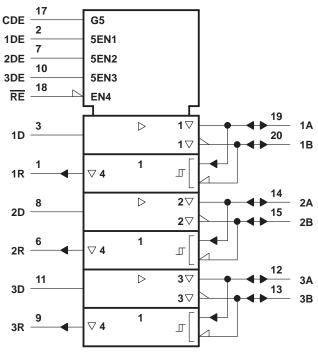
AVAILABLE OPTIONS

SKEW LIMIT	PART NUMBER				
10 ns	SN75ALS171DW	SN75ALS171J			
5 ns	SN75ALS171ADW				

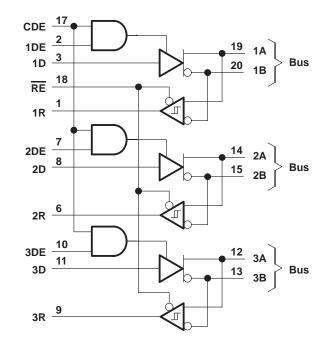


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logic symbol[†]

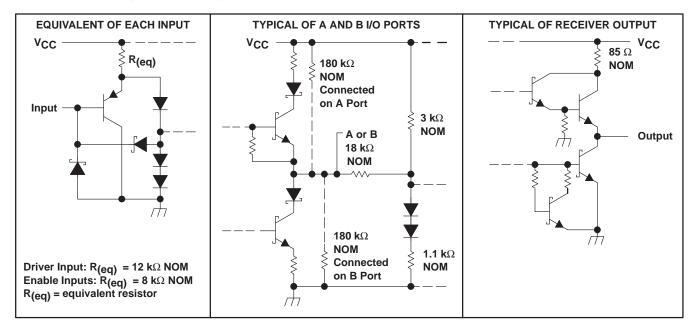


logic diagram (positive logic)



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

schematics of inputs and outputs





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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage, V _{CC} (see Note 1)	
Enable input voltage, V ₁	
Continuous total power dissipation	
Operating free-air temperature range, T _A	0°C to 70°C
Storage temperature range, T _{stg}	–65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds: DW package	
Lead temperature 1,6 mm (1/16 inch) from case for 60 seconds: J package .	300°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: All voltage values, except differential I/O bus voltage, are with respect to network ground terminal.

DISSIPATION RATING TABLE							
$\label{eq:package} \begin{array}{cc} T_A \leq 25^\circ C & \text{DERATING FACTOR} & T_A = 70^\circ C \\ \text{POWER RATING} & \text{ABOVE } T_A = 25^\circ C & \text{POWER RATING} \end{array}$							
DW	1125 mW	9.0 mW/°C	720 mW				
J	1025 mW	8.2 mW/°C	656 mW				

recommended operating conditions

		MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}		4.75	5	5.25	V
Voltage at any bus terminal (separately or common mode), VI or VIC		-7		12	V
High-level input voltage, VIH	D, CDE, DE, and RE	2			V
Low-level input voltage, VIL	D, CDE, DE, and RE			0.8	V
Differential input voltage, VID (see Note 2)				±12	V
	Driver			-60	mA
High-level output current, IOH	Receiver			-400	μΑ
	Driver			60	~ ^
Low-level output current, IOL	Receiver		-7 12 2 0.8 ±12 -60 -400 60 8 8	mA	
Operating free-air temperature, T _A		0		70	°C

NOTE 2: Differential-input/output bus voltage is measured at the noninverting terminal A with respect to the inverting terminal B.



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DRIVER SECTION

electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

_	PARAMETER	TEST CO	NDITIONS [†]	MIN	түр‡	MAX	UNIT
VIK	Input clamp voltage	lı = – 18 mA				-1.5	V
VO	Output voltage	IO = 0		0		6	V
Vон	High-level output voltage	V _{CC} = 4.75 V, V _{IL} = 0.8 V,	V _{IH} = 2 V, I _{OH} = -55 mA	2.7			V
Vol	Low-level output voltage	V _{CC} = 4.75 V, V _{IL} = 0.8 V,	V _{IH} = 2 V, I _{OL} = 55 mA			1.7	V
VOD1	Differential output voltage	IO = 0		1.5		6	V
VOD2	Differential output voltage	R _L = 100 Ω,	See Figure 1	1/2 VOD1 or 2§	2.5	5	V
		R _L = 54 Ω,	See Figure 1	1.5	2.5	5	
VOD3	Differential output voltage	$V_{\text{test}} = -7 \text{ V to } 12 \text{ V},$	See Figure 2	1.5		5	V
∆ Vod	Change in magnitude of differential output voltage¶					±0.2	V
Voc	Common-mode output voltage	$R_L = 54 \Omega$ or 100 Ω, See Fi	See Figure 1			3 -1	V
∆ V _{OC}	Change in magnitude of common-mode output voltage¶					±0.2	V
IO	Output current	Output disabled, See Note 3	$V_0 = 12 V$ $V_0 = -7 V$			1 -0.8	mA
ΊΗ	High-level enable-input current	D and DE CDE	V _{IH} = 2.7 V			20 60	
ΙIL	Low-level enable-input current	D and DE CDE	V _{IL} = 0.4 V			-100 -900	μA
		$V_{O} = -6 V$	1	+		-250	
		$V_{O} = 0$				-150	
los	Short-circuit output current	$V_{O} = V_{CC}$				250	mA
		$V_{O} = 8 V$		1		250	
ICC	Supply current	No load	Outputs enabled Outputs disabled		69 57	90 78	mA

[†] The power-off measurement in ANSI Standard EIA/TIA-422-B applies to disabled outputs only and is not applied to combined inputs and outputs. [‡] All typical values are at V_{CC} = 5 V and T_A = 25°C. § The minimum V_{OD2} with 100-W load is either 1/2 V_{OD2} or 2 V, whichever is greater.

 $I \Delta V_{OD}$ and ΔV_{OC} are the changes in magnitude of V_{OD} and V_{OC} , respectively, that occur when the input is changed from a high level to a low level.

NOTE 3: This applies for both power on and off; refer to EIA Standard RS-485 for exact conditions. The EIA/TIA-422-B limit does not apply for a combined driver and receiver terminal.



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switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

	PARAMETER		TEST COND	ITIONS	MIN	TYP†	MAX	UNIT
		ALS171	R ₁ = 54 Ω,	See Figure 3,	3		13	
		ALS171A	C _L = 50 pF	_	6		11	
^t d(OD)	Differential output delay time	ALS171			3		13	ns
		ALS171A	- C _L = 60 pF, R _{L2} = 75 Ω,	See Figure 6	6		11	
4	5 t	•	$R_L = 54 \Omega$, See Figure 3	C _L = 50 pF,		1	5	ns
^t sk(p)	Pulse skew [‡]		$R_{L1} = R_{L3} = 165 \Omega$, C _L = 60 pF,	R _{L2} = 75 Ω, See Figure 6		1	5	ns
		ALS171	R _L = 54 Ω,	C _L = 50 pF,			10	
• • •• •	0	ALS171A	See Figure 3				5	ns
^t sk(lim)	Skew limit§	ALS171	R _{L1} = R _{L3} = 165 Ω,	R _{L2} = 75 Ω,			10	
		ALS171A	$C_{L} = 60 \text{ pF},$	See Figure 6			5	
		-	$R_L = 54 \Omega$, See Figure 3	C _L = 50 pF,	3	8	13	
^t t(OD)	Differential-output transition time		$\begin{aligned} R_{L1} &= R_{L3} = 165 \ \Omega, \\ C_L &= 60 \ pF, \\ See Figure 6 \end{aligned}$	R _{L2} = 75 Ω, V _{TERM} = 5 V,	3	8	13	ns
^t PZH	Output enable time to high level		R _L = 110 Ω,	See Figure 4		30	50	ns
t _{PZL}	Output enable time to low level		R _L = 110 Ω,	See Figure 5		30	50	ns
^t PHZ	Output disable time from high level		R _L = 110 Ω,	See Figure 4	3	8	13	ns
^t PLZ	Output disable time from low level		R _L = 110 Ω,	See Figure 5	3	8	13	ns
^t PDE	Differential-output enable time		R _{L1} = R _{L3} = 165 Ω,	R _{L2} = 75 Ω,	8	30	45	ns
t _{PDZ}	Differential-output disable time		C _L = 60 pF,	See Figure 7	5	10	45	ns

[†] All typical values are at $V_{CC} = 5$ V and $T_A = 25^{\circ}C$.

[‡] Pulse skew is defined as the $|t_{d(ODH)} - t_{d(ODL)}|$ of each channel. § Skew limit is the maximum difference in propagation delay times between any two channels of one device and between any two devices. This parameter is applicable at one V_{CC} and operating temperature within the recommended operating conditions.

SYMBOL EQUIVALENTS

DATA-SHEET PARAMETER	EIA/TIA-422-B	RS-485
VO	V _{oa} , V _{ob}	V _{oa} , V _{ob}
V _{OD1}	Vo	V _o
VOD2	$V_t (R_L = 100 \Omega)$	$V_t (R_L = 54 \Omega)$
VOD3		V _t (Test Termination Measurement 2)
V _{test}		V _{tst}
$\Delta V_{OD} $	$ V_t - \overline{V}_t $	$ V_t - \overline{V}_t $
V _{OC}	V _{os}	V _{OS}
$\Delta V_{OC} $	$ V_{OS} - \overline{V}_{OS} $	$ V_{OS} - \overline{V}_{OS} $
los	_{sa} , I _{sb}	
lo	_{xa} , _{xb}	l _{ia} , l _{ib}



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RECEIVER SECTION

electrical characteristics over recommended ranges of common-mode input voltage, supply voltage, and operating free-air temperature (unless otherwise noted)

	PARAMETER	TEST C	TEST CONDITIONS		TYP†	MAX	UNIT
VIT+	Positive-going input threshold voltage	V _O = 2.7 V,	$I_{O} = -0.4 \text{ mA}$			0.3	V
V _{IT} -	Negative-going input threshold voltage	V _O = 0.5 V,	IO = 8 mA	-0.3‡			V
V _{hys}	Hysteresis voltage (V _{IT+} – V _{IT} _)				60		mV
VIK	Enable-input clamp voltage	lj = - 18 mA				-1.5	V
VOH	High-level output voltage	V _{ID} = 300 mV, See Figure 8	I _{OH} = -400 μA,	2.7			V
V _{OL}	Low-level output voltage	V _{ID} = -300 mV, See Figure 8	I _{OL} = 8 mA,			0.45	V
loz	High-impedance-state output current	$V_{O} = 0.4 \text{ V to } 2.4 \text{ V}$				±20	μA
1.		Other input = 0 V,	V _I = 12 V			1	4
1	Line input current	See Note 4	$V_{I} = -7 V$			-0.8	mA
IIН	High-level enable-input current	V _{IH} = 2.7 V				60	μΑ
۱ _{IL}	Low-level enable-input current	V _{IL} = 0.4 V				-300	μA
r _i	Input resistance			12			kΩ
los	Short-circuit output current	V _{ID} = 300 mV,	$V_{O} = 0$	-15		-85	mA
1	Supply ourrent	No load	Outputs enabled		69	90	m۸
ICC	Supply current	NU IUAU	Outputs disabled		57	78	mA

[†] All typical values are at $V_{CC} = 5$ V and $T_A = 25^{\circ}C$.

[‡] The algebraic convention, in which the less positive (more negative) limit is designated minimum, is used in this data sheet for common-mode input voltage and threshold voltage levels only.

NOTE 4: This applies for both power on and off; refer to EIA Standard RS-485 for exact conditions.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature range

	PARAMETER		TEST CONDITIONS	MIN	TYP†	MAX	UNIT
t	Propagation delay time, low- to high-level output	ALS171	$V_{ID} = -1.5 V$ to 1.5 V,	to 1.5 V, 9 19		19	
^t PLH	Propagation delay time, low- to high-level output	ALS171A	$C_{L} = 15 \text{ pF},$	11		16	ns
t	Propagation delay time, high- to low-level output	ALS171	T _A = 25°C,	9		19	ns
^t PHL	Propagation delay time, high- to low-level output	ALS171A	See Figure 9	11		16	
t _{sk(p)}	Pulse skew§		$V_{ID} = -1.5 \text{ V to } 1.5 \text{ V},$		2	5	ns
• · ··· ·	o	ALS171	$C_{L} = 15 \text{ pF},$			10	
^t sk(lim)	Skew limit [¶]	ALS171A	See Figure 9			5	ns
^t PZH	Output enable time to high level		C _L = 15 pF,		7	14	ns
^t PZL	Output enable time to low level		See Figure 10		7	14	ns
^t PHZ	PHZ Output disable time from high level		C _L = 15 pF,		20	35	ns
^t PLZ	Output disable time from low level		See Figure 10		8	17	ns

[†] All typical values are at V_{CC} = 5 V and T_A = 25°C.

§ Pulse skew is defined as the |tPLH-tPHL| of each channel.

Skew limit is the maximum difference in propagation delay times between any two channels of one device and between any two devices. This parameter is applicable at one V_{CC} and operating temperature within the recommended operating conditions.



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PARAMETER MEASUREMENT INFORMATION

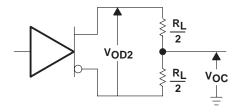


Figure 1. Driver V_{OD} and V_{OC}

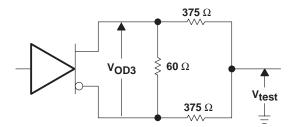
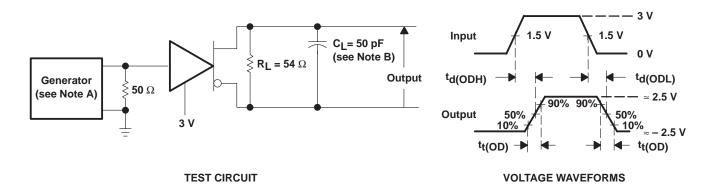


Figure 2. Driver VOD3



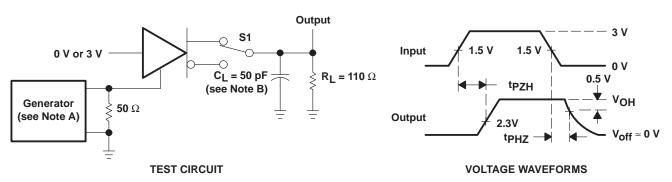
- NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR \leq 1 MHz, 50% duty cycle, t_f \leq 6 ns, t_f \leq 6 ns, Z_O = 50 Ω .
 - B. C_L includes probe and jig capacitance.

Figure 3. Driver Test Circuit and Voltage Waveforms



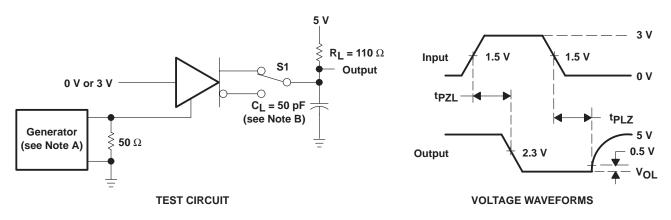
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PARAMETER MEASUREMENT INFORMATION



- NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR \leq 1 MHz, 50% duty cycle, t_f \leq 6 ns, t_f \leq 6 ns, Z_Q = 50 Ω .
 - B. CL includes probe and jig capacitance.

Figure 4. Driver Test Circuit and Voltage Waveforms

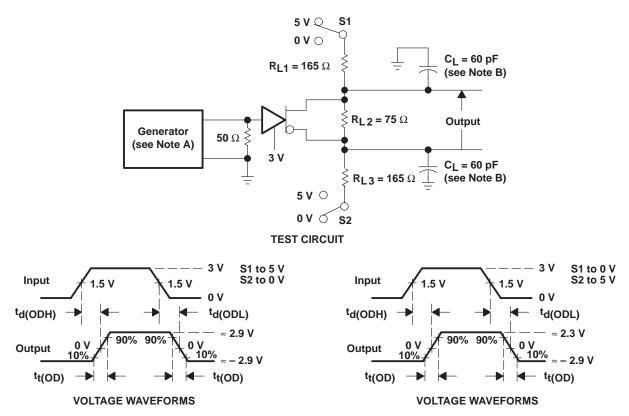


- NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR \leq 1 MHz, 50% duty cycle, t_f \leq 6 ns, t_f \leq 6 ns, Z_O = 50 Ω .
 - B. CL includes probe and jig capacitance.

Figure 5. Driver Test Circuit and Voltage Waveforms



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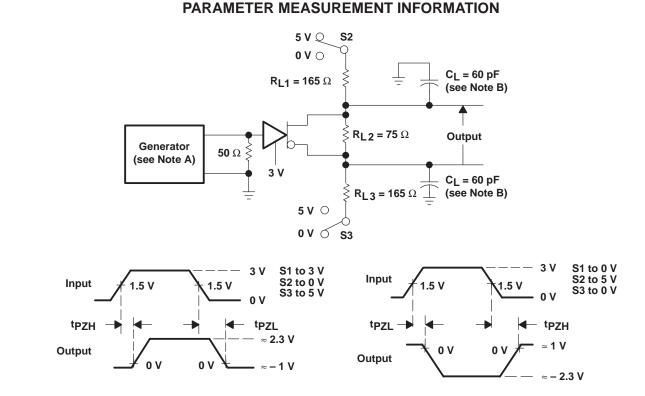
PARAMETER MEASUREMENT INFORMATION

- NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR \leq 1 MHz, 50% duty cycle, t_r \leq 6 ns, t_f \leq 6 ns, Z_O = 50 Ω .
 - B. C_{L} includes probe and jig capacitance.

Figure 6. Driver Test Circuit and Voltage Waveforms With Double-Differential-SCSI Termination for the Load



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NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR \leq 1 MHz, 50% duty cycle, t_f \leq 6 ns, t_f \leq 8 ns, t_f

B. CL includes probe and jig capacitance.

Figure 7. Driver Differential-Enable and Disable Times With a Double-SCSI Termination



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PARAMETER MEASUREMENT INFORMATION

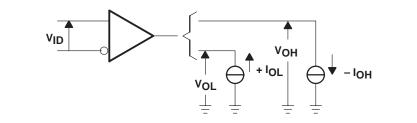
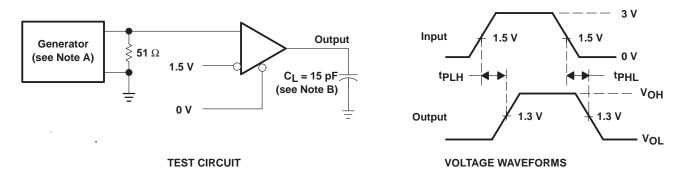


Figure 8. Receiver VOH and VOL

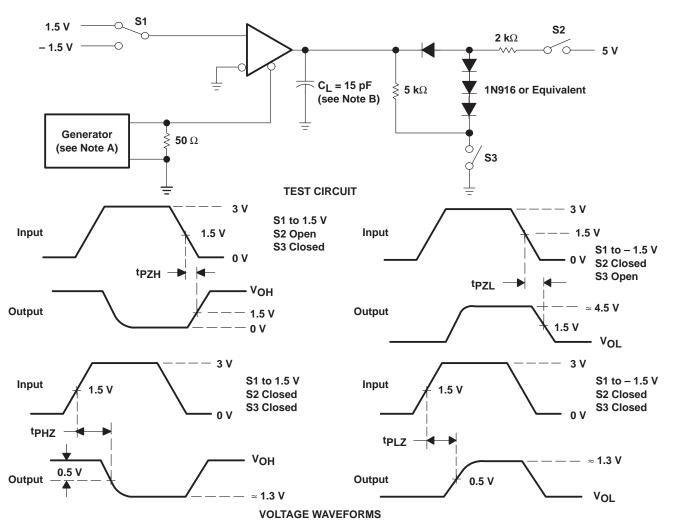


- NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR \leq 1 MHz, 50% duty cycle, t_r \leq 6 ns, t_f \leq 6 ns, Z_O = 50 Ω .
 - B. CL includes probe and jig capacitance.

Figure 9. Receiver Test Circuit and Voltage Waveforms



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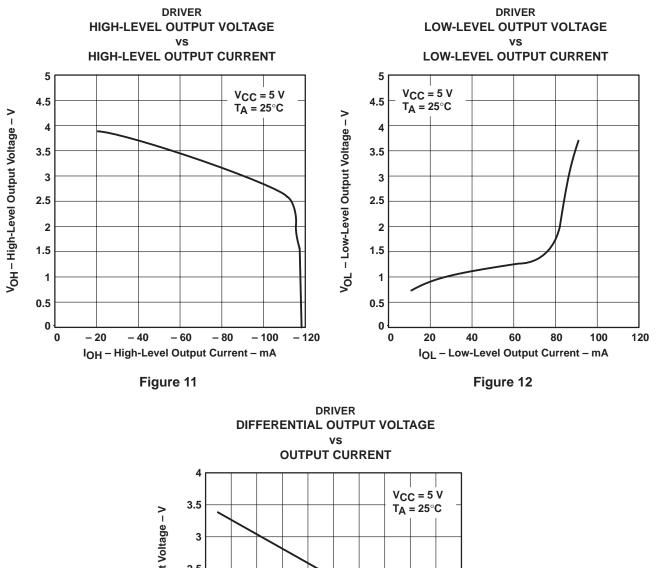
PARAMETER MEASUREMENT INFORMATION

- NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR \leq 1 MHz, 50% duty cycle, t_f \leq 6 ns, t_f \leq 6 ns, Z_O = 50 Ω .
 - B. CL includes probe and jig capacitance.

Figure 10. Receiver Test Circuit and Voltage Waveforms



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TYPICAL CHARACTERISTICS

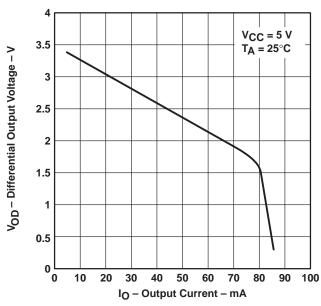
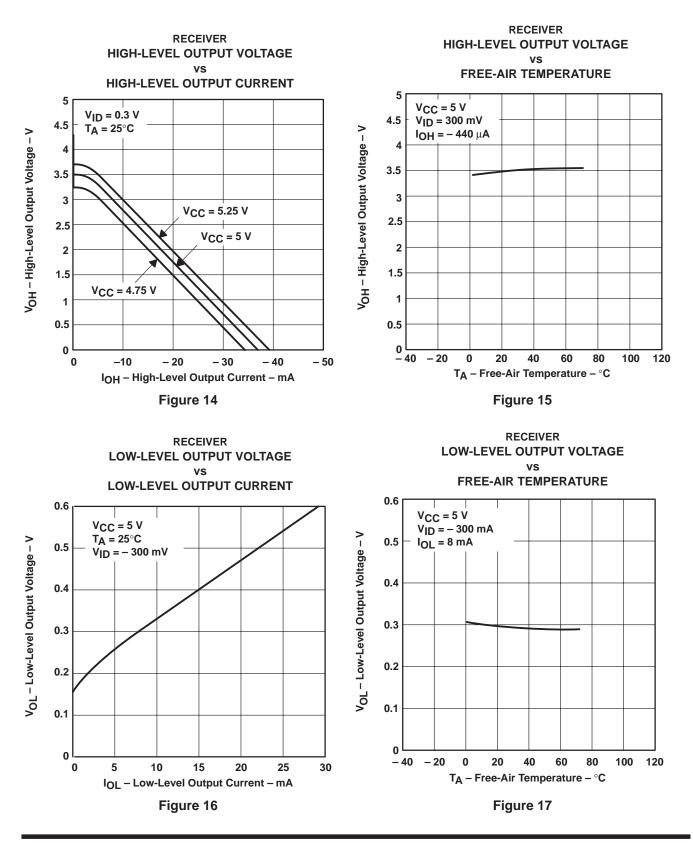


Figure 13



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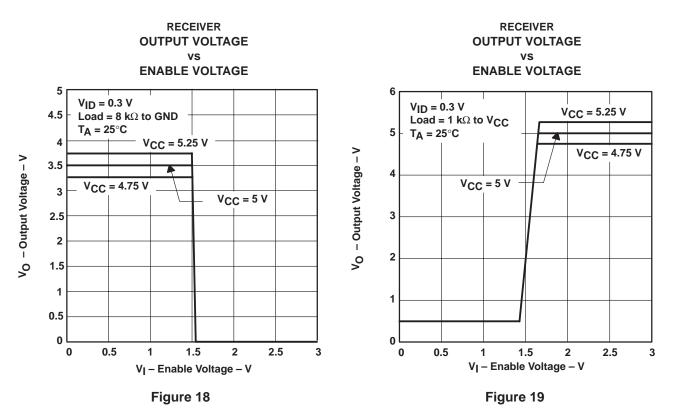
TYPICAL CHARACTERISTICS





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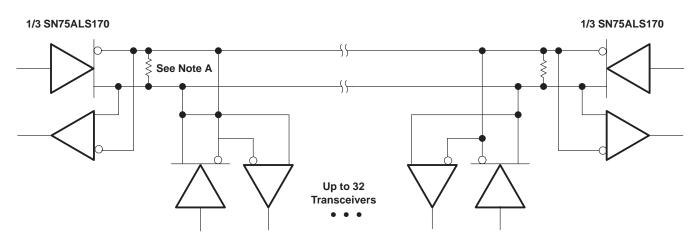






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APPLICATION INFORMATION



NOTE A: The line should be terminated at both ends in its characteristic impedance. Stub lengths off the main line should be kept as short as possible.

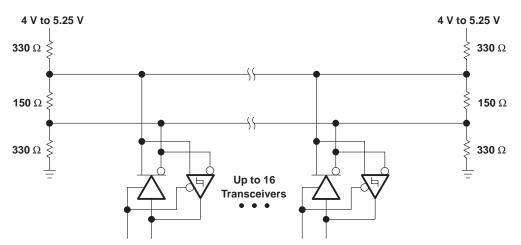
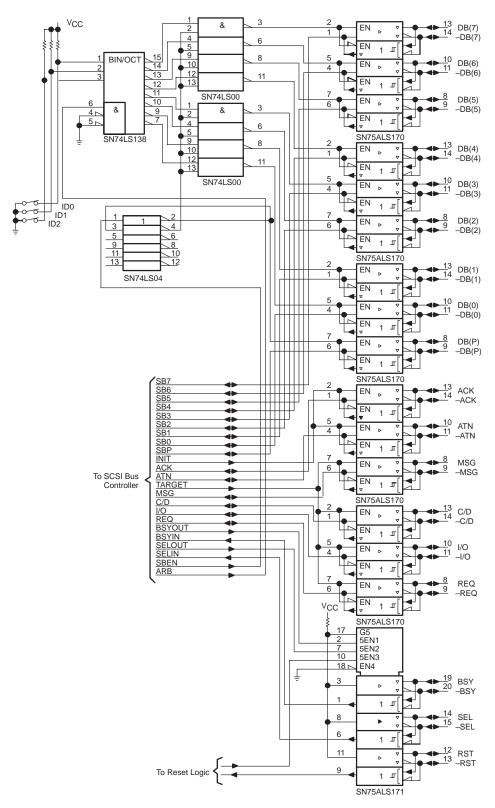


Figure 20. Typical Application Circuit

Figure 21. Typical Differential SCSI Application Clrcuit



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APPLICATION INFORMATION

Figure 22. Typical Differential SCSI Bus Interface Implementation



TEXAS

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Packag Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN75ALS171ADW	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75ALS171ADWE4	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75ALS171ADWG4	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75ALS171ADWR	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75ALS171ADWRE4	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75ALS171ADWRG4	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75ALS171DW	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75ALS171DWE4	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75ALS171DWG4	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75ALS171DWR	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75ALS171DWRE4	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75ALS171DWRG4	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75ALS171J	OBSOLETE	CDIP	J	20		TBD	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. **TBD:** The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered

at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. **Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*	All dimensions are nominal												
	Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
	SN75ALS171ADWR	SOIC	DW	20	2000	330.0	24.4	10.8	13.1	2.65	12.0	24.0	Q1
	SN75ALS171DWR	SOIC	DW	20	2000	330.0	24.4	10.8	13.1	2.65	12.0	24.0	Q1



PACKAGE MATERIALS INFORMATION

11-Mar-2008



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN75ALS171ADWR	SOIC	DW	20	2000	346.0	346.0	41.0
SN75ALS171DWR	SOIC	DW	20	2000	346.0	346.0	41.0

J (R-GDIP-T**) 14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

DW (R-PDSO-G20)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-013 variation AC.



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